

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74LCX74F, TC74LCX74FN, TC74LCX74FT

Low-Voltage Dual D-Type Flip-Flop with 5-V Tolerant Inputs and Outputs

The TC74LCX74F/FN/FT is a high-performance CMOS D-type flip-flop. Designed for use in 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

The device is designed for low-voltage (3.3 V) V_{CC} applications, but it could be used to interface to 5-V supply environment for inputs.

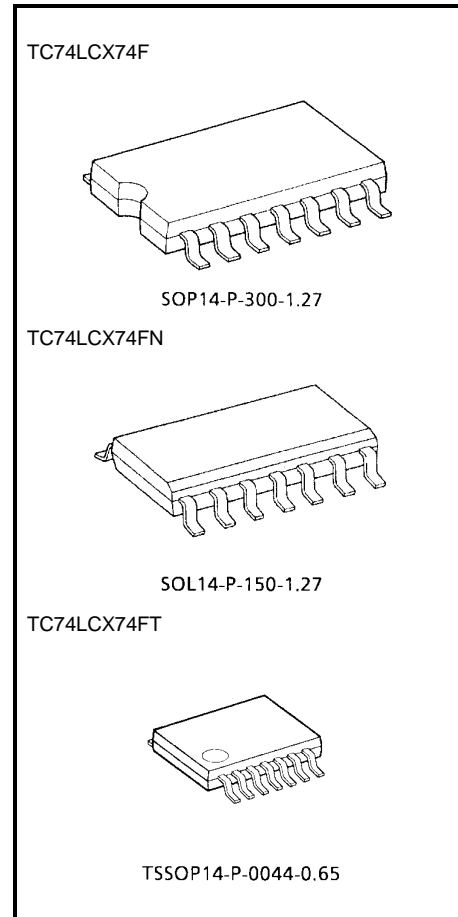
The signal level applied to the D input is transferred to Q output during the positive going transition of the CK pulse. \overline{CLR} and \overline{PR} are independent of the CK and are accomplished by setting the appropriate input low.

All inputs are equipped with protection circuits against static discharge.

Features

- Low-voltage operation: $V_{CC} = 2.0$ to 3.6 V
- High-speed operation: $t_{pd} = 7.0$ ns (max) ($V_{CC} = 3.0$ to 3.6 V)
- Output current: $|I_{OH}|/I_{OL} = 24$ mA (min) ($V_{CC} = 3.0$ V)
- Latch-up performance: ± 500 mA
- Available in JEDEC SOP, JEITA SOP and TSSOP
- Power-down protection provided on all inputs and outputs
- Pin and function compatible with the 74 series (74AC/VHC/HC/F/ALS/LS etc.) 74 type

Note: xxxFN (JEDEC SOP) is not available in Japan.

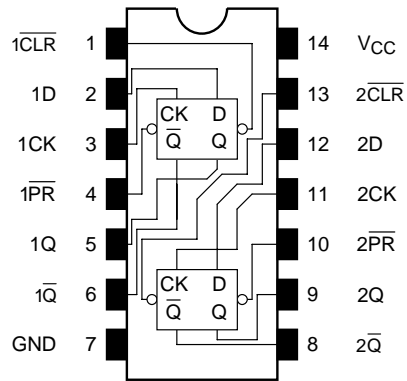
**Weight**

SOP14-P-300-1.27: 0.18 g (typ.)

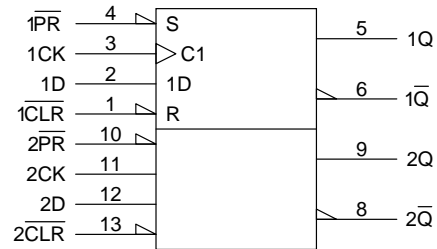
SOL14-P-150-1.27: 0.12 g (typ.)

TSSOP14-P-0044-0.65: 0.06 g (typ.)

Pin Assignment (top view)



IEC Logic Symbol



Truth Table

Inputs				Outputs		Function
CLR	PR	D	CK	Q	Q̄	
L	H	X	X	L	H	Clear
H	L	X	X	H	L	Preset
L	L	X	X	H	H	—
H	H	L	↑	L	H	—
H	H	H	↑	H	L	—
H	H	X	↕	Q _n	Q̄ _n	No change

X: Don't care

Maximum Ratings

Characteristics	Symbol	Rating	Unit
Power supply voltage	V _{CC}	-0.5 to 7.0	V
DC input voltage	V _{IN}	-0.5 to 7.0	V
DC output voltage	V _{OUT}	-0.5 to 7.0 (Note 1)	V
		-0.5 to V _{CC} + 0.5 (Note 2)	
Input diode current	I _{IK}	-50	mA
Output diode current	I _{OK}	±50 (Note 3)	mA
DC output current	I _{OUT}	±50	mA
Power dissipation	P _D	180	mW
DC V _{CC} /ground current	I _{CC} /I _{GND}	±100	mA
Storage temperature	T _{stg}	-65 to 150	°C

Note 1: V_{CC} = 0 V

Note 2: High or low state. I_{OUT} absolute maximum rating must be observed.

Note 3: V_{OUT} < GND, V_{OUT} > V_{CC}

Recommended Operating Conditions

Characteristics	Symbol	Rating	Unit
Power supply voltage	V_{CC}	2.0 to 3.6	V
		1.5 to 3.6 (Note 4)	
Input voltage	V_{IN}	0 to 5.5	V
Output voltage	V_{OUT}	0 to 5.5 (Note 5)	V
		0 to V_{CC} (Note 6)	
Output current	I_{OH}/I_{OL}	± 24 (Note 7)	mA
		± 12 (Note 8)	
Operating temperature	T_{opr}	-40 to 85	°C
Input rise and fall time	dt/dv	0 to 10 (Note 9)	ns/V

Note 4: Data retention only

Note 5: $V_{CC} = 0$ V

Note 6: High or low state

Note 7: $V_{CC} = 3.0$ to 3.6 V

Note 8: $V_{CC} = 2.7$ to 3.0 V

Note 9: $V_{IN} = 0.8$ to 2.0 V, $V_{CC} = 3.0$ V

Electrical Characteristics

DC Characteristics ($T_a = -40$ to 85°C)

Characteristics		Symbol	Test Condition	V_{CC} (V)	Min	Max	Unit
Input voltage	H-level	V_{IH}	—	2.7 to 3.6	2.0	—	V
	L-level	V_{IL}	—	2.7 to 3.6	—	0.8	
Output voltage	H-level	V_{OH}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OH} = -100 \mu A$	2.7 to 3.6	$V_{CC} - 0.2$	V
				$I_{OH} = -12$ mA	2.7	2.2	
				$I_{OH} = -18$ mA	3.0	2.4	
				$I_{OH} = -24$ mA	3.0	2.2	
	L-level	V_{OL}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OL} = 100 \mu A$	2.7 to 3.6	—	0.2
				$I_{OL} = 12$ mA	2.7	—	0.4
				$I_{OL} = 16$ mA	3.0	—	0.4
				$I_{OL} = 24$ mA	3.0	—	0.55
Input leakage current		I_{IN}	$V_{IN} = 0$ to 5.5 V	2.7 to 3.6	—	± 5.0	μA
Power-off leakage current		I_{OFF}	$V_{IN}/V_{OUT} = 5.5$ V	0	—	10.0	μA
Quiescent supply current		I_{CC}	$V_{IN} = V_{CC}$ or GND	2.7 to 3.6	—	10.0	μA
			$V_{IN} = 3.6$ to 5.5 V	2.7 to 3.6	—	± 10.0	
Increase in I_{CC} per input		ΔI_{CC}	$V_{IH} = V_{CC} - 0.6$ V	2.7 to 3.6	—	500	

AC Characteristics (Ta = -40 to 85°C)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Min	Max	Unit
Maximum clock frequency	f _{max}	Figure 1, Figure 2	2.7	—	—	MHz
			3.3 ± 0.3	150	—	
Propagation delay time (CK-Q, \bar{Q})	t _{pLH} t _{pHL}	Figure 1, Figure 2	2.7	—	8.0	ns
			3.3 ± 0.3	1.5	7.0	
Propagation delay time (\bar{CLR} , \bar{PR} -Q, \bar{Q})	t _{pLH} t _{pHL}	Figure 1, Figure 4	2.7	—	8.0	ns
			3.3 ± 0.3	1.5	7.0	
Minimum pulse width (CK)	t _W (H) t _W (L)	Figure 1, Figure 2	2.7	3.3	—	ns
			3.3 ± 0.3	3.3	—	
Minimum pulse width (\bar{CLR} , \bar{PR})	t _W (L)	Figure 1, Figure 4	2.7	3.6	—	ns
			3.3 ± 0.3	3.3	—	
Minimum setup time	t _s	Figure 1, Figure 2	2.7	2.5	—	ns
			3.3 ± 0.3	2.5	—	
Minimum hold time	t _h	Figure 1, Figure 2	2.7	1.5	—	ns
			3.3 ± 0.3	1.5	—	
Minimum removal time	t _{rem}	Figure 1, Figure 3	2.7	3.0	—	ns
			3.3 ± 0.3	2.5	—	
Output to output skew	t _{osLH} t _{osHL}	(Note 10)	2.7	—	—	ns
			3.3 ± 0.3	—	1.0	

Note 10: Parameter guaranteed by design.
(t_{osLH} = |t_{pLHm} - t_{pLHn}|, t_{osHL} = |t_{pHLm} - t_{pHLn}|)

Dynamic Switching Characteristics
(Ta = 25°C, input: t_r = t_f = 2.5 ns, C_L = 50 pF, R_L = 500 Ω)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Typ.	Unit
Quiet output maximum dynamic V _{OL}	V _{OLP}	V _{IH} = 3.3 V, V _{IL} = 0 V	3.3	0.8	V
Quiet output minimum dynamic V _{OL}	V _{OLV}	V _{IH} = 3.3 V, V _{IL} = 0 V	3.3	0.8	V

Capacitive Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Typ.	Unit
Input capacitance	C _{IN}	—	3.3	7	pF
Output capacitance	C _{OUT}	—	0	8	pF
Power dissipation capacitance	C _{PD}	f _{IN} = 10 MHz (Note 11)	3.3	25	pF

Note 11: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC} (opr) = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/2 \text{ (per bit)}$$

AC Test Circuit

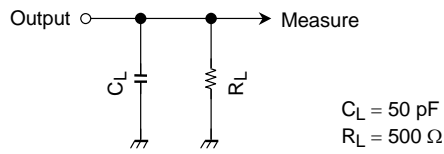


Figure 1

AC Waveform

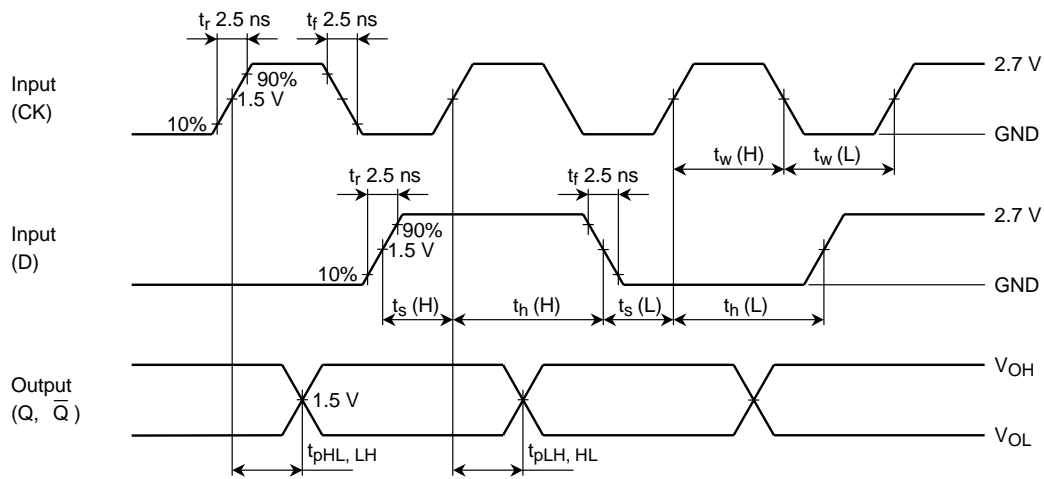


Figure 2 t_{pLH} , t_{pHL} , t_w , t_s , t_h

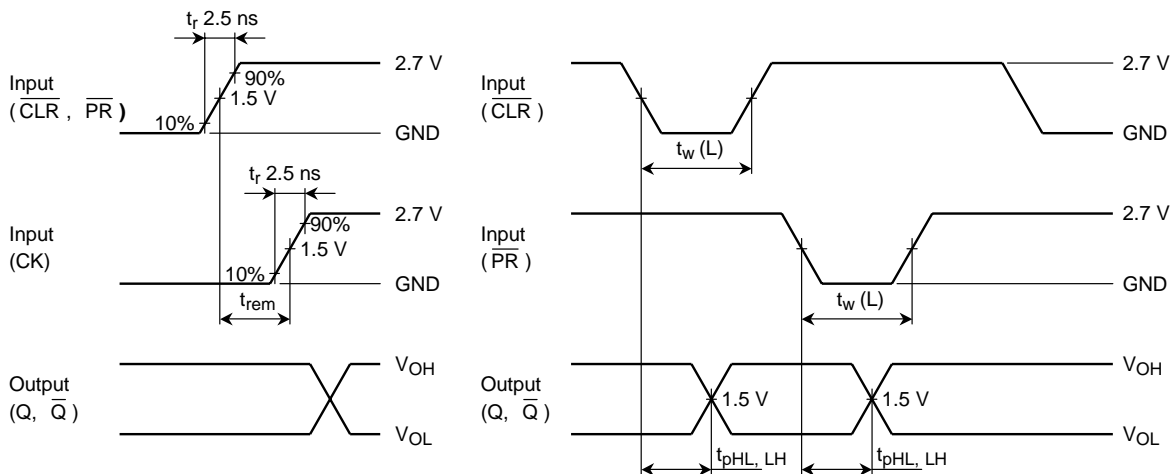
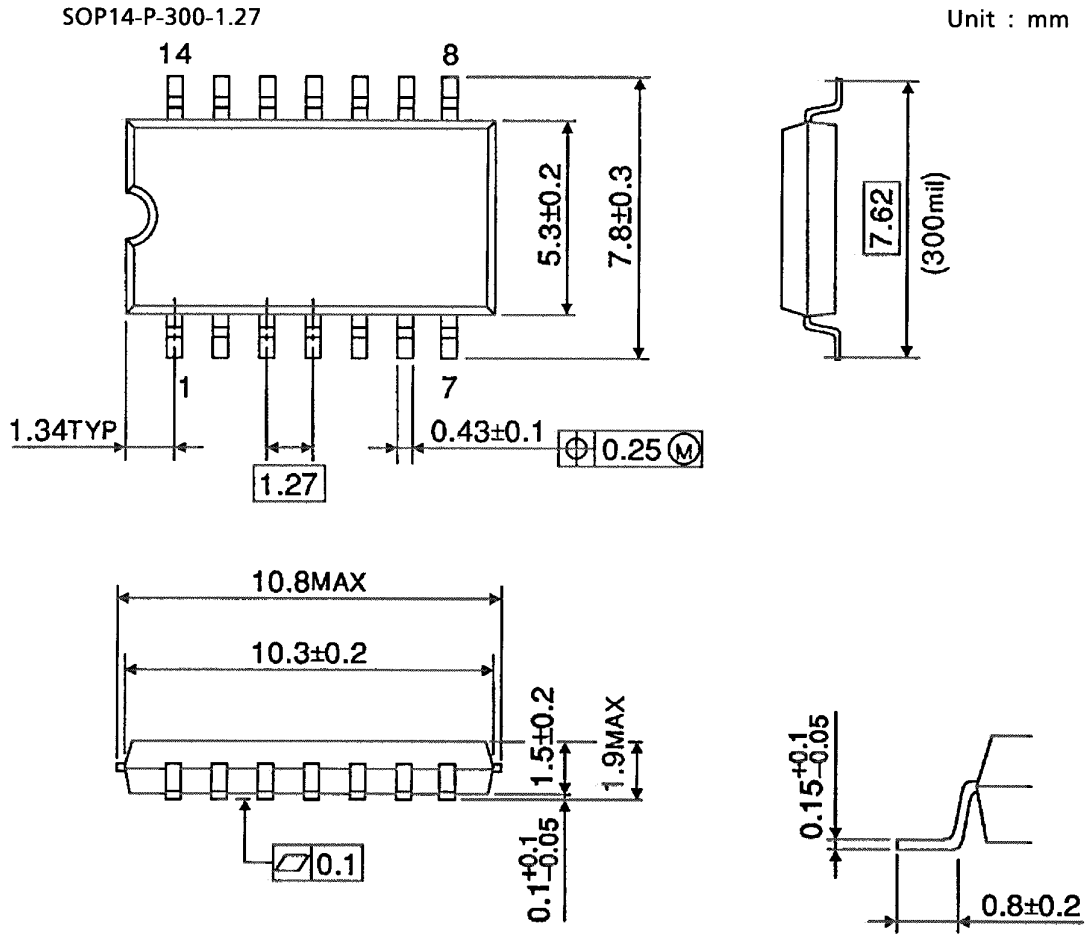


Figure 3 t_{rem}

Figure 4 t_{pLH} , t_{pHL}

Package Dimensions



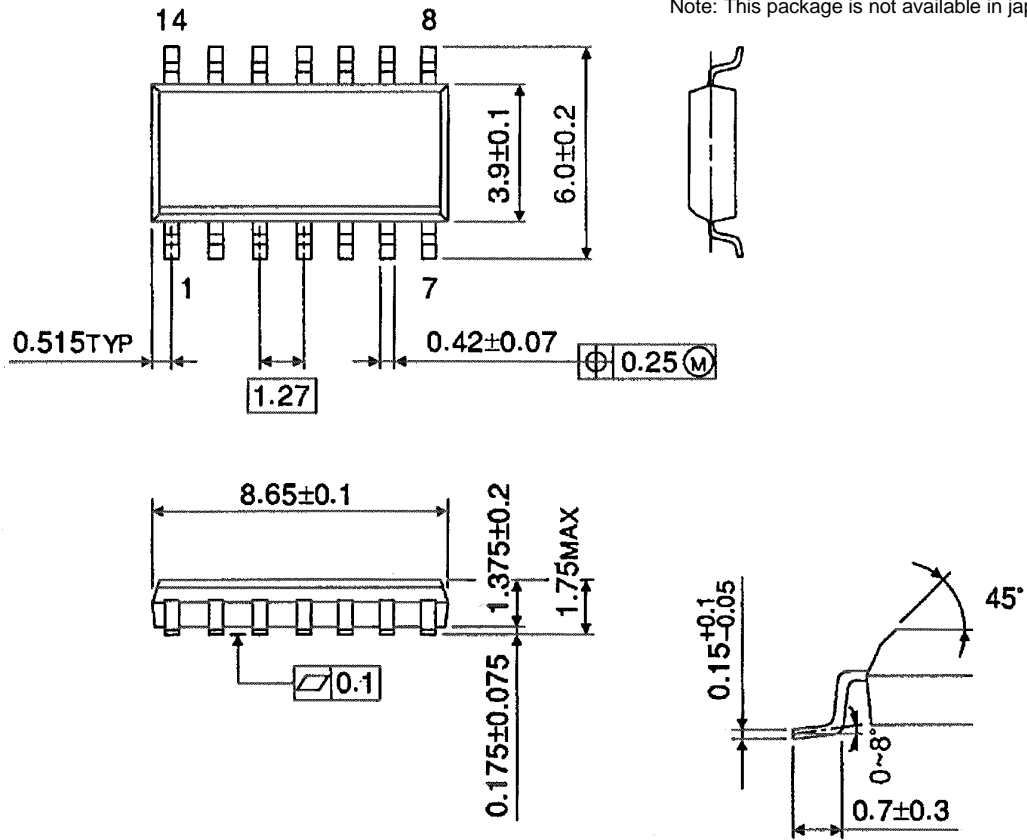
Weight: 0.18 g (typ.)

Package Dimensions

SOL14-P-150-1.27

Unit : mm

Note: This package is not available in Japan.

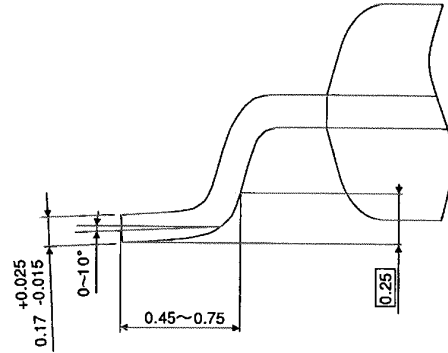
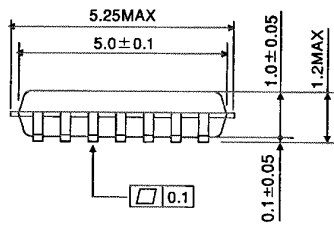
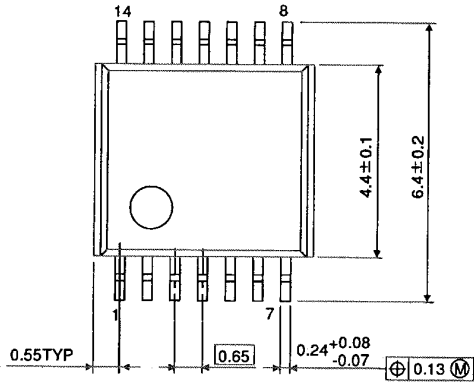


Weight: 0.12 g (typ.)

Package Dimensions

TSSOP14-P-0044-0.65

Unit : mm



Weight: 0.06 g (typ.)

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